

NID5001N

Preferred Device

Self-protected FET with Temperature and Current Limit

HDPlus devices are an advanced series of power MOSFETs which utilize ON Semiconductor's latest MOSFET technology process to achieve the lowest possible on-resistance per silicon area while incorporating smart features. Integrated thermal and current limits work together to provide short circuit protection. The devices feature an integrated Drain-to-Gate Clamp that enables them to withstand high energy in the avalanche mode. The Clamp also provides additional safety margin against unexpected voltage transients. Electrostatic Discharge (ESD) protection is provided by an integrated Gate-to-Source Clamp.

Features

- Low $R_{DS(on)}$
- Current Limitation
- Thermal Shutdown with Automatic Restart
- Short Circuit Protection
- I_{DSS} Specified at Elevated Temperature
- Avalanche Energy Specified
- Slew Rate Control for Low Noise Switching
- Overvoltage Clamped Protection

MOSFET MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage Internally Clamped	V_{DSS}	42	Vdc
Drain-to-Gate Voltage Internally Clamped ($R_{GS} = 1.0\text{ M}\Omega$)	V_{DGR}	42	Vdc
Gate-to-Source Voltage	V_{GS}	± 14	Vdc
Drain Current Continuous	I_D	Internally Limited	
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 1) @ $T_A = 25^\circ\text{C}$ (Note 1) @ $T_A = 25^\circ\text{C}$ (Note 2)	P_D	64 1.0 1.56	W
Thermal Resistance - Junction-to-Tab Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	$R_{\theta JC}$ $R_{\theta JA}$ $R_{\theta JA}$	1.95 120 80	$^\circ\text{C/W}$
Single Pulse Drain-to-Source Avalanche Energy ($V_{DD} = 25\text{ Vdc}$, $V_{GS} = 5.0\text{ Vdc}$, $I_L = 4.5\text{ Apk}$, $L = 120\text{ mH}$, $R_G = 25\text{ }\Omega$)	E_{AS}	1215	mJ
Operating and Storage Temperature Range	T_J , T_{stg}	-55 to 150	$^\circ\text{C}$

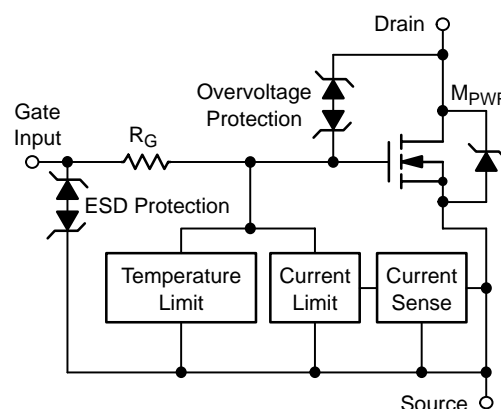
1. Minimum FR4 PCB, steady state.
2. Mounted onto a 2" square FR4 board (1" square, 2 oz. Cu 0.06" thick single-sided, $t = \text{steady state}$).



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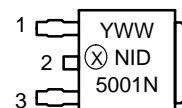
<http://onsemi.com>

V_{DSS} (Clamped)	$R_{DS(on)}$ TYP	I_D MAX (Limited)
42 V	23 m Ω @ 10 V	33 A*



DPAK
CASE 369A
STYLE 2

MARKING DIAGRAM



NID5001N = Device Code
Y = Year
WW = Work Week

1 = Gate
2 = Drain
3 = Source

ORDERING INFORMATION

Device	Package	Shipping
NID5001NT4	DPAK	2500/Tape & Reel

*Max current may be limited below this value depending on input conditions.

Preferred devices are recommended choices for future use and best overall value.

NID5001N

MOSFET ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-to-Source Clamped Breakdown Voltage (V _{GS} = 0 Vdc, I _D = 250 μAdc) (V _{GS} = 0 Vdc, I _D = 250 μAdc, T _J = 150°C)	V _{(BR)DSS}	42 42	46 44	50 50	Vdc
Zero Gate Voltage Drain Current (V _{DS} = 32 Vdc, V _{GS} = 0 Vdc) (V _{DS} = 32 Vdc, V _{GS} = 0 Vdc, T _J = 150°C)	I _{DSS}		1.5 6.5	3.0	μAdc
Gate Input Current (V _{GS} = 5.0 Vdc, V _{DS} = 0 Vdc) (V _{GS} = -5.0 Vdc, V _{DS} = 0 Vdc)	I _{GSS}		50 550	100 1000	μAdc

ON CHARACTERISTICS

Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 1.2 mAdc) Threshold Temperature Coefficient	V _{GS(th)}	1.0	1.8 5.0	2.0	Vdc -mV/°C
Static Drain-to-Source On-Resistance (Note 3) (V _{GS} = 10 Vdc, I _D = 5.0 Adc, T _J @ 25°C) (V _{GS} = 10 Vdc, I _D = 5.0 Adc, T _J @ 150°C)	R _{DS(on)}		23 43	29 55	mΩ
Static Drain-to-Source On-Resistance (Note 3) (V _{GS} = 5.0 Vdc, I _D = 5.0 Adc, T _J @ 25°C) (V _{GS} = 5.0 Vdc, I _D = 5.0 Adc, T _J @ 150°C)	R _{DS(on)}		28 50	34 60	mΩ
Source-Drain Forward On Voltage (I _S = 5 A, V _{GS} = 0 V)	V _{SD}		0.85	1.1	V

SWITCHING CHARACTERISTICS

Turn-on Time	V _{GS} = 5.0 V _{dc} V _{DD} = 25 V _{dc} I _D = 1.0 A _{dc} Ext R _G = 2.5 Ω	T _(on)		32	40	μs
Turn-off Time		T _(off)		68	75	
Turn-on Time	V _{GS} = 10 V _{dc} V _{DD} = 25 V _{dc} I _D = 1.0 A _{dc} Ext R _G = 2.5 Ω	T _(on)		11	15	μs
Turn-off Time		T _(off)		86	95	
Slew Rate On	R _L = 4.7 Ω, V _{in} = 0 to 10 V, V _{DD} = 12 V	-dV _{DS} /dt _{on}		0.5		V/μs
Slew-Rate Off	R _L = 4.7 Ω, V _{in} = 10 to 0 V, V _{DD} = 12 V	dV _{DS} /dt _{off}		0.35		V/μs

SELF PROTECTION CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Current Limit	(V _{GS} = 5.0 Vdc) V _{DS} = 10 V (V _{GS} = 5.0 Vdc, T _J = 150°C)	I _{LIM}	21 12	30 19	36 30	Adc
	(V _{GS} = 10 Vdc) V _{DS} = 10 V (V _{GS} = 10 Vdc, T _J = 150°C)		29 13	41 24	49 31	Adc
Temperature Limit (Turn-off f)	V _{GS} = 5.0 Vdc	T _{LIM(off)}	150	175	200	°C
Temperature Limit (Circuit Reset)	V _{GS} = 5.0 Vdc	T _{LIM(on)}	135	160	185	°C
Temperature Limit (Turn-off f)	V _{GS} = 10 Vdc	T _{LIM(off)}	150	165	185	°C
Temperature Limit (Circuit Reset)	V _{GS} = 10 Vdc	T _{LIM(on)}	135	150	170	°C

ESD ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

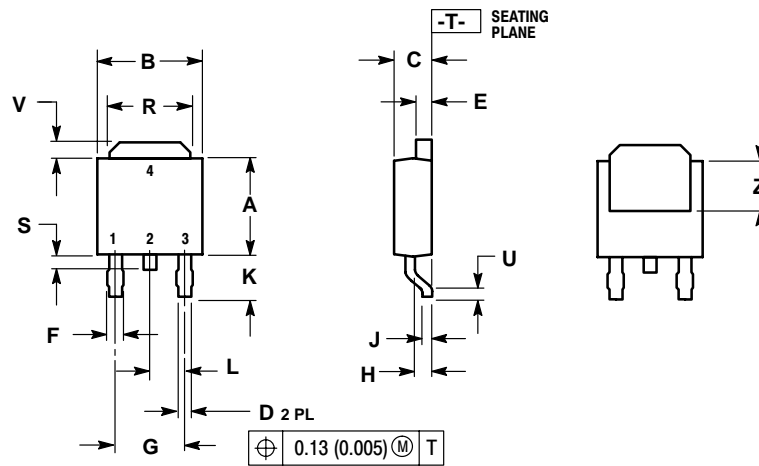
Electro-Static Discharge Capability Human Body Model (HBM) Machine Model (MM)	ESD	4000 400			V
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3. Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%.

NID5001N

PACKAGE DIMENSIONS

DPAK
CASE 369A-13
ISSUE AB




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	---	0.51	---
V	0.030	0.050	0.77	1.27
Z	0.138	---	3.51	---

STYLE 2:

- PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

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